I hereby certify that this paper (along with any paper referred to as being attached or enclosed) is being deposited with the U.S. Postal Service as Express Mail, Label No. EV 756262837 US, on the date shown below in an envelope addressed to: MS RCE, Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450.

NOV 2 1 (Michelle Jacobson)

Docket No.: 60803 (49381)

(PATENT)

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Patent Application of:

Kazuya Fujita et al.

Application No.: 10/773,809

Filed: February 5, 2004

For: SOLID STATE IMAGING DEVICE, SEMICONDUCTOR WAFER, OPTICAL DEVICE MODULE, METHOD OF SOLID STATE IMAGING DEVICE FABRICATION, AND METHOD OF OPTICAL DEVICE

MODULE FABRICATION

Confirmation No.: 8452

Art Unit: 2814

Examiner: W. S. Louie

AMENDMENT AFTER FINAL ACTION UNDER 37 C.F.R. 1.116

MS RCE Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450

Dear Sir:

INTRODUCTORY COMMENTS

In response to the Final Office Action dated June 26, 2006, please enter the following amendment, as this amendment is being filed along with a Request for Continued Examination (RCE):

Amendments to the Claims are reflected in the listing of claims which begins on page 2 of this paper.

Remarks begin on page 9 of this paper.